

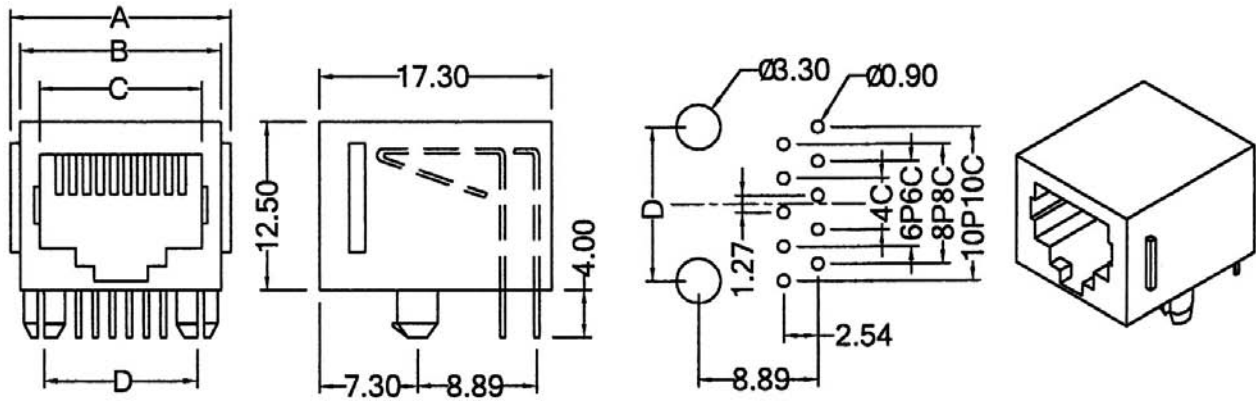
## SIDE ENTRY MODULAR PCB JACK 4P+6P+8P+10P PROFILE=12.50MM (UNSHIELDED)

### SPECIFICATIONS

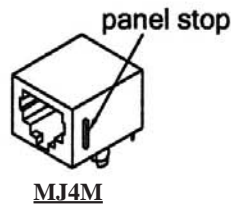
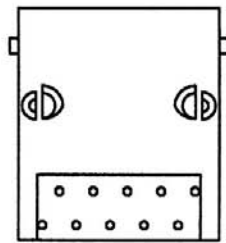
**Insulation Resistance:** 500MΩ Min.  
**Contact Resistance:** 20mΩ Max.  
**Rating Current:** 1.5A Max.  
**Rating Voltage:** 120V AC.  
**Dielectric Voltage:** 1000 Vrms 60 Sec. Min.  
**Temperature Range:** -40°C / +85°C  
**Durability:** 500 Mating cycles Min.

### MATERIALS

**Housing:** PBT Glass Filled (UL 94V-0)  
**Soldering Temperature:** 235°C  
**Color:** Black  
**Spring Wire:** Phosphor Bronze  
 Gold plating Over Nickel  
**All materials must be RoHS compliant.**



Recommended P.C. Board Layout  
(TOP VIEW)



No. of Positions	No. of Contacts	A	B	C	D
4P	4C	13.50	11.20	7.80	7.60
6P	2C/4C/6C	15.60	13.20	10.00	10.16
8P	8C	17.60	15.00	11.90	11.43
10P	10C	17.60	15.00	11.90	11.43

### ORDERING INFORMATION:

P/N MJ  $\frac{x}{1} - \frac{x}{2} \frac{x}{3} B$

- PANEL STOP OPTION:  
 "4M" WITH PANEL STOP  
 "4N" W/O PANEL STOP
- NO. OF POSITIONS & CONTACTS:  
 "66" 6P6C  
 "64" 6P4C  
 "88" 8P8C  
 "00" 10P10C  
 "44" 4P4C
- CONTACT FINISH:  
 "A" 6 MICROINCH GOLD  
 "B" 15 MICROINCH GOLD  
 "C" 30 MICROINCH GOLD  
 "D" 50 MICROINCH GOLD